Contact Name  Title - Contact Phone - Contact*  Product-Env-Stewards Authorized Representative*  Product-Env-Stewards Product Enviro Compliance Product-Env-Stewards Product-Env-Stewards Product-Env-Stewards Product-Enviro Compliance Product-Env-Stewards Product	© Copyrig	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
Company name* Company unique ID  Unique ID Authority  Respose Date*  2024-05-17  2024-05-17  2024-05-17  Contact Name  Title - Contact*  Product Enviro Compliance  NA  Product Enviro Compliance  NA  Product-Env-Stewards											Mfg Informat	ion		
Seemi	ormation													
Title - Contact Name Product Envi-Stewards Product Envi-Compliance Product Envi-Stewards Product Envi-Steward	Company name*			Company unique ID			Unique ID Authority				Response Date*			
Product Env-Stewards uthorized Representative* Title - Representative Product Enviro Compliance NA Product Env-Stewards Product Enviro Compliance NA Product Env-Stewards Product Enviro Compliance NA Product-Env-Stewards Product-Env-Stewards Na Product-Env-Stewards Na Product-Env-Stewards Na Nanufacturing Site Weight* UOM NSVF4017SG4T1G BIP NPN 100mA 12V fT=10G 2024-05-17 CNG 7.73 mg  Annufacturing Proccess Information  Terminal Plating / Grid Array Material Terminal Base Alloy I-STD-020 MSL Rating Peak Process Body Temperature Nax Time at Peak Temperature Number of Reflow Cycles Contains Bi CU Alloy 1 260 C 30 Seconds 3	onsemi										2024-05-17			
Authorized Representative* Product-Env-Stewards Product Enviro Compliance Requester Item Number Requester Item	Contact Name			Title - Contact			Phone - Contact*			Emai	Email - Contact*			
Product Envr-Stewards Requester Item Number Mfr Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM NSVF4017SG4T1G BIP NPN 100mA 12V fT=10G 2024-05-17 CNG 7.73 mg  Manufacturing Process Information  Terminal Plating / Grid Array Material Terminal Base Alloy Terminal Plating / Grid Array Material Terminal Base Alloy Terminal Base Alloy Terminal Plating / Grid Array Material Terminal Base Alloy Termin	Product-Env-Stewards			Product Enviro Compliance			NA			Prod	Product-Env-Stewards@onsemi.com			
Requester Item Number	Authorized Representative* Title			Γitle - Representative			Phone - Representative*			Emai	Email - Representative*			
NSVF4017SG4T1G   BIP NPN 100mA 12V fT=10G   2024-05-17   CNG   7.73   mg	Product-Env-Stewards			Product Enviro Compliance			NA			Prod	Product-Env-Stewards@onsemi.com			
Manufacturing Proccess Information  Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles contains Bi Comments	Requester Item Number Mfr Item		Afr Item Numb	m Number Mfr Item Name			Effective Date	Version	Manufacturing S	ite	Weight*	UOM	Unit Type	
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles contains Bi  CU Alloy 1 260 C 30 seconds 3		NSVF4017SG4T1G BI		4T1G BIP NPN	BIP NPN 100mA 12V fT=10G		2024-05-17		CNG		7.73	mg	Each	
contains Bi CU Alloy 1 260 C 30 seconds 3 omments			Tomain	al Daga Allay	I STD 020 M	ICI Dating	Dools Duo	osa Dadu Tama	May Time of	Pools Towns	Mysesh Nyamb	acm of Deflow Cw	olog	
omments	· · ·			•		ISL Kating					i	ber of Reflow Cyc	cies	
	ms Bi		CU Alle	loy	1		200	<u> </u>	30	sec	conds 3			
vei 1 - maximum ume at peak temperature during soldering is 10-50 seconds	4:41-	- 4		-:-10.20										
or more information regarding material composition please refer to page 3														

RoHS Material Composition Declaration			Declaration Type *	Detail	led					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the					
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.04	mg	Supplier	Silicon (Si)	7440-21-3		0.04	mg
Lead Frame	3.1	mg	Supplier	Silver (Ag)	7440-22-4		0.0967	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0059	mg
			В	Nickel (Ni)	7440-02-0		0.0161	mg
			Supplier	Iron (Fe)	7439-89-6		0.0778	mg
			Supplier	Copper (Cu)	7440-50-8		2.8991	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0043	mg
Mold Compound-Black	4.5	mg		Epoxy Phenol Resin	proprietary data		0.036	mg
			Supplier	Carbon Black (C)	1333-86-4		0.045	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.27	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.6	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.54	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.009	mg
Plating	0.07	mg	В	Bismuth (Bi)	7440-69-9		0.0004	mg
			Supplier	Tin (Sn)	7440-31-5		0.0696	mg
Wire Bond - Au	0.02	mg	Supplier	Gold (Au)	7440-57-5		0.02	mg